



**UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Liu, *et al.* )  
Serial No.: 10/807,605 )  
Filed: March 23, 2004 )  
For: *Methods of Forming LaNiO<sub>3</sub> Conductive* )  
*Layers, Ferro-Electric Devices with* )  
*LaNiO<sub>3</sub> Layers and Precursor Formation* )  
*Solutions* )  
Examiner: LAM, Cathy Fong )  
Group Art Unit: 1775 )  
Atty. Docket: 02EK-105600 )

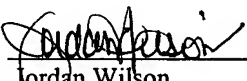
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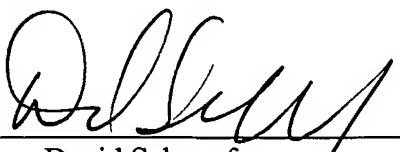
**LETTER TRANSMITTING FORMAL DRAWINGS  
TO THE OFFICIAL DRAFTSPERSON**

Sir:

Transmitted herewith are Replacement Sheets for FIGS. 5 – 11 (drawing sheets 3/8, 4/8,  
5/8 and 6/8) for the above-identified application.

June 2, 2006  
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Respectfully submitted,

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